RoHS



Vishay General Semiconductor

Ultrafast Avalanche SMD Rectifier



SMA (DO-214AC)

PRIMARY CHARACTERISTICS			
I _{F(AV)}	1.5 A		
V_{RRM}	1000 V		
I _{FSM}	30 A		
I _R	5.0 μΑ		
t _{rr}	75 ns		
V_{F}	1.7 V		
E _R	20 mJ		
T _J max.	150 °C		
Package	SMA (DO-214AC)		
Diode variations	Single		

FEATURES

- Low profile package
- Ideal for automated placement
- · Glass passivated pellet chip junction
- Low reverse current
- High reverse voltage
- Ultra fast reverse recovery time
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- AEC-Q101 qualified
- Material categorization: for definitions of compliance please see <u>www.vishav.com/doc?99912</u>

TYPICAL APPLICATIONS

For use in high frequency rectification and freewheeling application in switching mode converters and inverters for consumer, computer, automotive and telecommunication.

MECHANICAL DATA

Case: SMA (DO-214AC)

Molding compound meets UL 94 V-0 flammability rating Base P/N-E3 - RoHS-compliant, commercial grade Base P/NHE3_X - RoHS-compliant and AEC-Q101 qualified ("_X" denotes revision code e.g. A, B,...)

Terminals: Matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

E3 suffix meets JESD 201 class 2 whisker test, HE3 suffix meets JESD 201 class 2 whisker test

Polarity: Color band denotes the cathode end

MAXIMUM RATINGS (T _A = 25 °C unless otherwise noted)			
PARAMETER	SYMBOL BYG23M		UNIT
Device marking code		BYG23M	
Maximum repetitive peak reverse voltage	V _{RRM}	1000	V
Average forward current at T _A = 65 °C	I _{F(AV)}	1.5	Α
Peak forward surge current 10 ms single half sine-wave superimposed on rated load	I _{FSM}	30	А
Pulse energy in avalanche mode, non repetitive (inductive load switch off) $I_{(BR)R} = 1 \text{ A}$, $T_J = 25 ^{\circ}\text{C}$	E _R	E _R 20	
Operating junction and storage temperature range	T _J , T _{STG}	-55 to +150	°C



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ELECTRICAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted)						
PARAMETER	TEST CONDITIONS		SYMBOL	BYG23M	UNIT	
Minimum breakdown voltage	I _R = 100 μA		V_{BR}	1000	V	
Maximum instantaneous voltage	I _F = 1.0 A	T _J = 25 °C	V _F ⁽¹⁾	1.7	V	
		T _J = 150 °C		1.35]	
Maximum reverse current	VD = VDDM	T _J = 25 °C	I _R	5	μΑ	
		T _J = 125 °C		50		
Maximum reverse recovery time	I _F = 0.5 A, I _R =	1.0 A, I _{rr} = 0.25 A	t _{rr}	75	ns	

Note

 $^{^{(1)}\,}$ Pulse test: 300 μs pulse width, 1 % duty cycle

THERMAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted)			
PARAMETER	SYMBOL	BYG23M	UNIT
Typical thermal resistance, junction to case	$R_{ heta JC}$	25	°C/W
	R ₀ JA ⁽¹⁾	150	
Typical thermal resistance, junction to ambient	R _{0JA} (2)	125	°C/W
	R ₀ JA (3)	100	

Notes

- $^{(1)}$ Mounted on epoxy-glass hard tissue, 17 mm² 35 μ m Cu
- (2) Mounted on epoxy-glass hard tissue, 50 mm² 35 μm Cu
- (3) Mounted on Al-oxide-ceramic (Al₂O₃), 50 mm² 35 μm Cu

ORDERING INFORMATION (Example)					
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QANTITY	DELIVERY MODE	
BYG23M-E3/TR	0.064	TR	1800	7" diameter plastic tape and reel	
BYG23M-E3/TR3	0.064	TR3	7500	13" diameter plastic tape and reel	
BYG23MHE3_A/H (1)	0.064	Н	1800	7" diameter plastic tape and reel	
BYG23MHE3_A/I (1)	0.064	I	7500	13" diameter plastic tape and reel	

Note

⁽¹⁾ AEC-Q101 qualified

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RATINGS AND CHARACTERISTICS CURVES (T_A = 25 °C unless otherwise noted)

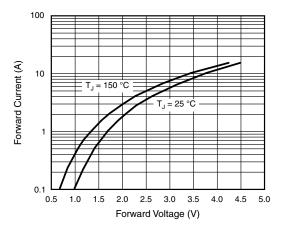


Fig. 1 - Max. Forward Current vs. Forward Voltage

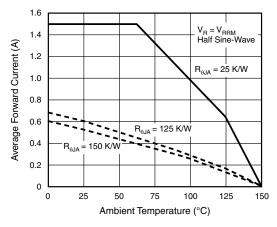


Fig. 2 - Max. Average Forward Current vs. Ambient Temperature

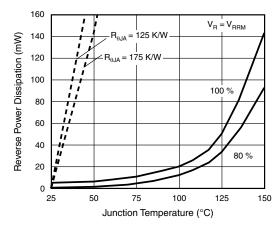


Fig. 3 - Max. Reverse Power Dissipation vs. Junction Temperature

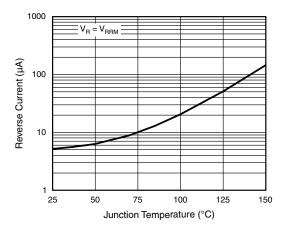


Fig. 4 - Reverse Current vs. Junction Temperature

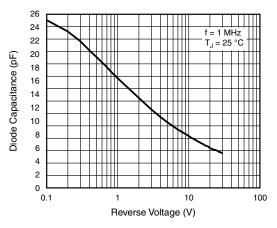


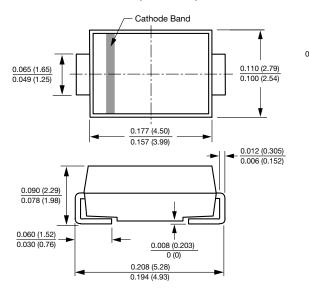
Fig. 5 - Diode Capacitance vs. Reverse Voltage



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PACKAGE OUTLINE DIMENSIONS in inches (millimeters)

SMA (DO-214AC)



Mounting Pad Layout 0.066 (1.68) MIN. 0.060 (1.52) MIN. 0.208 (5.28) REF.



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